

FDD7030BL/FDU7030BL

30V N-Channel PowerTrench^ò MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{\text{DS}(\text{ON})}$, fast switching speed and extremely low $R_{\text{DS}(\text{ON})}$ in a small package.

Applications

- DC/DC converter
- Motor Drives

Features

- 56 A, 30 V $R_{DS(ON)} = 9.5 \text{ m}\Omega$ @ $V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 13 \text{ m}\Omega$ @ $V_{GS} = 4.5 \text{ V}$
- Low gate charge
- Fast Switching
- High performance trench technology for extremely low $R_{\mbox{\scriptsize DS(ON)}}$



Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Para	meter		Ratings	Units
V _{DSS}	Drain-Source Voltage			30	V
V _{GSS}	Gate-Source Voltage			±20	V
I _D	Continuous Drain Current	@T _C =25°C	(Note 3)	56	Α
		@T _A =25°C	(Note 1a)	14	
		Pulsed	(Note 1a)	100	
P _D	Power Dissipation	@T _C =25°C	(Note 3)	60	W
		@T _A =25°C	(Note 1a)	2.8	
		@T _A =25°C	(Note 1b)	1.3	
T_J,T_{STG}	Operating and Storage Ju	nction Tempera	ture Range	−55 to +175	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	2.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	45	
$R_{\theta JA}$		(Note 1b)	96	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape width	Quantity
FDD7030BL	FDD7030BL	D-PAK (TO-252)	13"	12mm	2500 units
FDU7030BL	FDU7030BL	I-PAK (TO-251)	Tube	N/A	75

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-Sc	ource Avalanche Ratings (Not	e 2)				
E _{AS}	Drain-Source Avalanche Energy	Single Pulse, V _{DD} = 15 V, I _D = 14A			174	mJ
I _{AS}	Drain-Source Avalanche Current				14	Α
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{D} = 250 \mu\text{A}$	30			V
$\Delta BV_{DSS} \over \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A,Referenced to 25°C		26		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μΑ
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1	1.8	3	V
$\Delta V_{GS(th)} \over \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 μ A,Referenced to 25°C		- 5		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = 10 \text{ V}, I_D = 14 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 12 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 14 \text{ A}, T_J = 125^{\circ}\text{C}$	18-	7.5 9.6 11	9.5 13 16	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	50			Α
g FS	Forward Transconductance	V _{DS} = 10 V, I _D = 14 A	0	56		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	CO.		1425		pF
C _{oss}	Output Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$		350		pF
C _{rss}	Reverse Transfer Capacitance	f = 1.0 MHz		150		pF
R _G	Gate Resistance	V _{OSC} = 15 mV, f = 1.0 MHz		1.3		pF
Switchir	ng Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time			11	20	ns
t _r	Turn-On Rise Time	$V_{DD} = 15 \text{ V}, \qquad I_{D} = 1 \text{ A},$		9	18	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		31	50	ns
t _f	Turn-Off Fall Time			13	23	ns
Q _g	Total Gate Charge			14	20	nC
Q _{gs}	Gate-Source Charge	$V_{DS} = 15V$, $I_{D} = 14 A$, $V_{GS} = 5 V$		4		nC
Q _{qd}	Gate-Drain Charge	VGS - V		5		nC

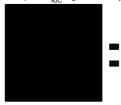
Electrical Characteristics

 $T_A = 25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-Source Diode Characteristics and Maximum Ratings						
Is	Maximum Continuous Drain-Source Diode Forward Current				2.3	Α
V _{SD}	Drain–Source Diode Forward Voltage V _{GS} = 0 V, I _S = 2.3 A (Note 2)			0.74	1.2	V
t _{rr}	Diode Reverse Recovery Time $I_F = 14 \text{ A}, d_{iF}/d_t = 100 \text{ A/}\mu\text{s}$			23		nS
Q _{rr}	Diode Reverse Recovery Charge			11		nC

Notes:

1. R_{8JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) $R_{\theta JA} = 45^{\circ}\text{C/W}$ when mounted on a 1in^2 pad of 2 oz copper

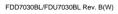


b) $R_{\theta JA} = 96^{\circ}C/W$ when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

יייפארייים (אייפאר) where P_D is maximum power dissipation at $T_C = 25^{\circ}C$ and $R_{DS(on)}$ is at $T_{J(max)}$ and $V_{GS} = 10V$. Package current limitation is 21A 3. Maximum current is calculated as:



Typical Characteristics

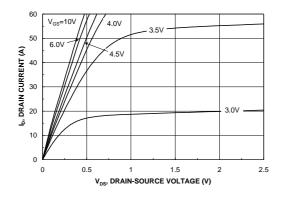


Figure 1. On-Region Characteristics

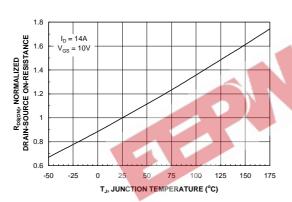


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage

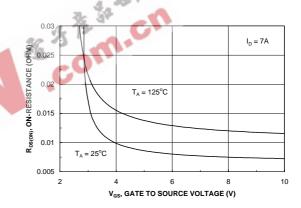


Figure 3. On-Resistance Variation withTemperature

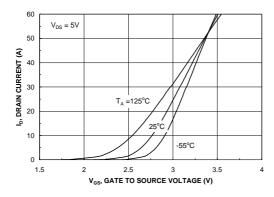


Figure 4. On-Resistance Variation with Gate-to-Source Voltage

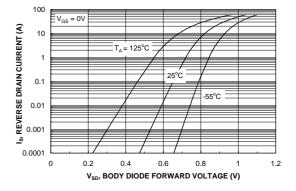
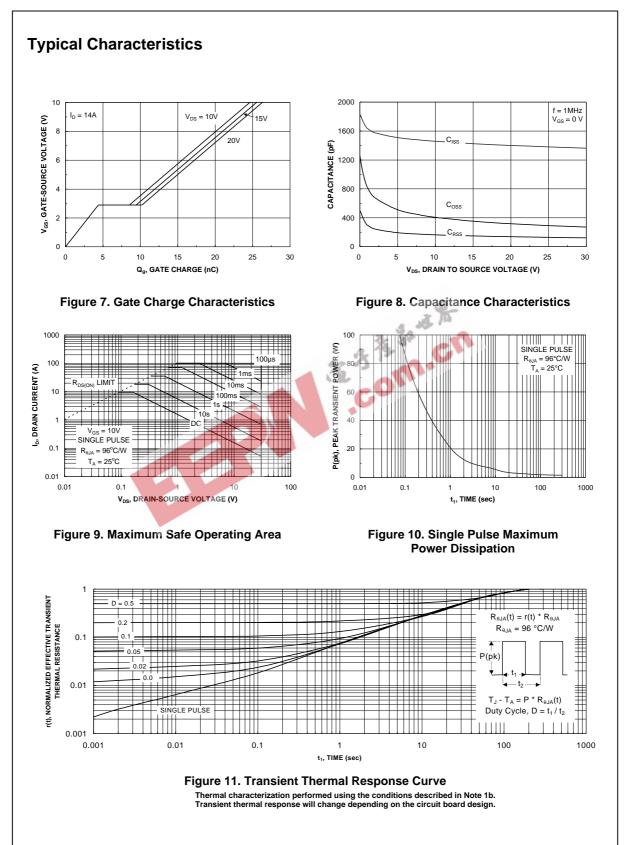


Figure 5. Transfer Characteristics

Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature



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